Overview

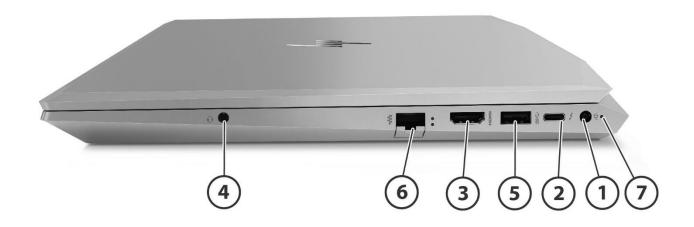
HP ZBook 15v G5 Mobile Workstation



LEFT VIEW

- (2) USB-A 3.0
- 2. SD Card reader

- Security cable slot 3.
- Storage Usage Indicator LED



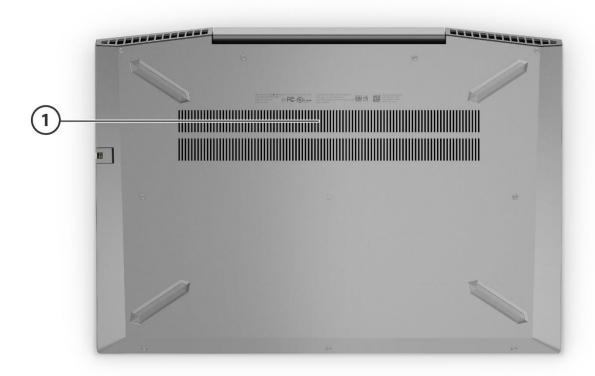
RIGHT VIEW

- 1. power connector
- 2. USB Type-C™ (Thunderbolt™ 3, DisplayPort™ 1.2, USB 3.1) 5. USB 3.0 Charging
- 3. HDMI 2.0

- 4. headphone/microphone combo
- 6. Ethernet port (RJ-45)
- 7. Power LED



Overview



BOTTOM VIEW

1. Fan Venting



Overview

At A Glance

- Eye-catching industrial design, aluminum and magnesium-reinforced chassis with HP's turbo silver color provides optimal durability with minimal weight.
- Featuring HP Spill Resistant Keyboard with Clickpad to manage most commonly used functions with a single keystroke..
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures
- HP Performance Advisor for optimal configuration, compatibility and performance
- Optional Workstation-caliber graphics:
 - NVIDIA ® Quadro® discrete graphics featuring NVIDIA® Optimus technology:
 - NVIDIA® Quadro® P600 (4GB GDDR5)
- Intel® Integrated graphics: Intel® UHD Graphics 630 integrated on Core™ i7. Intel® UHD Graphics P630 integrated on Xeon® processors.
- Choice of 8th generation Intel® Core™ i5 quad-core and Intel® Core™ i7 hexa-core or Intel® Xeon® hexa-core processors with option Intel® vPro™ technology.
- Populate up to two SODIMM slots supporting up to 32 GB DDR4-2667MHz dual-channel memory. Up to 32GB ECC DDR4-2667MHz dual-channel memory available with Intel® Xeon® processors.
- Supports multi-display, including up to three (3) displays without a docking solution, with hybrid graphics enabled.
 Supports up to five (5) displays or (2) 4K displays with HP Thunderbolt™ Dock G2 (sold separately), with hybrid graphics enabled.
- Choice of 15.6-inch diagonal LED-backlit displays:
 - FHD IPS anti-glare, 220nits (1920 x 1080);
 - o FHD IPS touch screen with Corning® Gorilla® Glass 4, 250 nits (1920 x 1080);
 - UHD IPS anti-glare, 340nits (3840 x 2160)
- One (1) Thunderbolt[™] 3 port (supporting DP 1.3, USB 3.1, PCIe Gen 3 devices) on the new USB-C[™] connector, for high speed data/video/audio transfer support.
- Flexible wireless connectivity options:
 - o Intel® Dual Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth 5.0 combo adaptor (non-vPro™) or Intel® Dual Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth 5.0 combo adaptor (vPro™)
- Optimize your audio experience for conference calls and remote collaboration with optional HD webcam, dual-array
 microphones, and premium speakers. Custom-tuned by HP and Bang & Olufsen optimized for high fidelity audio with
 immersive surround sound with deep, rich bass and crystal-clear dialog without distortion at high volume, and new
 discrete amp.
- HP Long life battery solution: 4-cell (70 WHr) or 3-cell (52.5 WHr) supporting HP Fast Charge capability
- Three dedicated drive slots. (2) M.2 slots and (1) 2.5" drive bays supporting up to 6TB of data.
- Security features including HP Client Security Manager, managed via single console.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

OPERATING SYSTEM

Preinstalled Windows 10 Pro 64 – HP recommends Windows 10 Pro*

Windows 10 Home 64 Plus*

Windows 10 Pro 64*

Windows 10 Pro 64 Workstation Plus*

FreeDOS 2.0

Supported Windows 10 Enterprise 64*

*Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com

PROCESSOR*

8th Generation Intel® Core™ i7-8850H vPro™ processor with Intel® UHD Graphics 630 (2.6 GHz base frequency, up to 4.3 GHz with Intel® Turbo Boost Technology, 9 MB cache, 6 cores)

8th Generation Intel® Core™ i7-8750H with Intel® UHD Graphics 630 (2.2 GHz base frequency, up to 4.1 GHz with Intel® Turbo Boost Technology, 9 MB cache, 6 cores)

8th Generation Intel® Core™ i5-8400H vPro™ processor with Intel® UHD Graphics 630 (2.5 GHz base frequency, up to 4.2 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores)

8th Generation Intel® Core™ i5-8300H with Intel® UHD Graphics 630 (2.6 GHz base frequency, up to 4.0 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores)

Intel® Xeon® E-2176M vPro™ processor with Intel® UHD Graphics P630 (2.7 GHz base frequency, up to 4.4 GHz with Intel® Turbo Boost Technology, 12 MB cache, 6 cores)

*Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Note: In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD 7th generation and forward processors or provide any Windows®8 or Windows 7 drivers on http://www.support.hp.com

CHIPSET

Mobile Intel® CM246 integrated with processor



Features

INTEL® CORE™ I5 WITH VPRO/CORE I7 WITH VPRO/XEON® WITH VPRO TECHNOLOGY CAPABLE

Intel® Core™ i5 with vPro™, Core™ i7 with vPro™ and Xeon® with vPro™ technology is a selectable feature that is available on units configured with select processors, a qualified Intel® WLAN module and a preinstalled Windows® operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel® Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.

* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of Intel® Core™ i5 with vPro™/Core™ i7 with vPro™/Xeon® with vPro™ technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro™/Core i7 with vPro™/XEON® with vPro™ technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

GRAPHICS

Integrated

Intel® UHD Graphics 630^{1,2} Intel® UHD Graphics P630^{1,2}

Discrete

NVIDIA® Quadro® P600 (4 GB GDDR5 dedicated)

NOTE 1: UHD content required to view UHD images

NOTE 2: Intel® UHD graphics 630 is configurable as a standalone graphics option; Intel® UHD graphics P630 only used when NVIDIA® Optimus™ Technology is enabled.

Multi-Display Support

Without HP Thunderbolt™ Dock G2:

HP ZBook 15v with hybrid graphics and without the use of the dock supports up to a maximum of 3 independent displays. These three displays are the internal panel plus two external displays connected to the two following ports: HDMI 2.0, Thunderbolt™ 3.

With HP Thunderbolt™ Dock G2:

HP Thunderbolt[™] Dock when used together with the HP ZBook 15v configuration with hybrid graphics, supports a maximum of 5 independent displays provided DisplayPort[™] is connected. These five displays are internal panel, one external display connected to the system's HDMI port and 3 external displays connected to the dock's Type-C, or VGA, and two DisplayPort[™] ports. If Thunderbolt[™] only port on the dock is connected, then the 3 external displays will not function.



Features

DISPLAY

15.6" diagonal FHD IPS anti-glare LED-backlit 220nits (1920 x 1080); 15.6" diagonal FHD IPS LED-backlit touch screen with Corning® Gorilla® Glass 4, 250 nits (1920 x 1080); 15.6" diagonal 4K IPS anti-glare LED-backlit 340nits (3840 x 2160)

STORAGE AND DRIVES*

(2) M.2 SATA SED Solid State Drive

256GB SATA Solid State Drive 1TB SATA State Solid Drive 256GB M.2 SATA Self-Encrypting Drive (SED) Solid State Drive 512GB M.2 SATA FIPS 140-2 Solide State Drive

HP Z Turbo Drive (PCIe NVMe Solid State Drive)

256GB M.2 PCIe NVMe™ TLC Solid State Drive 2TB M.2 PCIe® NVMe™ TLC Solid State Drive 256GB M.2 PCIe® NVMe™ TLC Self-Encrypting Drive (SED) Solid State Drive 512GB M.2 PCIe® NVMe™ TLC Self-Encrypting Drive (SED) Solid State Drive 360GB M.2 PCIe NVMe TLC Solid State Drive

(1) 2.5" Storage Bay Drives*

2TB SATA (5400 rpm) Hard Disk Drive 500GB SATA (7200 rpm) Hard Disk Drive 1TB SATA (7200 rpm) Hard Disk Drive 500GB SATA Self-Encrypting Drive (SED) (7200 rpm) Hard Disk Drive 500GB SATA FIPS 140-2 (7200 rpm) Hard Disk Drive 500GB SATA SSHD (Hybrid Drive) (8 GB cache) 2TB SATA SSHD (Hybrid Drive) (8 GB cache)

HP 3D DriveGuard (Windows only)

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive. Uses three-axis digital motion detection with intelligent sensitivity to help protect the hard drive during normal use from shock and vibration. The digital accelerometer temporarily halts all data transfer and parks the hard drive when abrupt motion is detected.

*For storage drives GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.



Features

DRIVE CONTROLLERS

2.5" Storage Bays and M.2 Storage Bay (SATA): SATA-3 or SATA-2 for HDD and SATA-3 for SSD

AID: 0, 1 supported*

NOTE: Raid 0, 1 supported only on SATA drives.

MEMORY

32 GB DDR4-2667 ECC or non-ECC SDRAM
Two SODIMM slots supporting dual-channel memory

4 GB, 8GB and 16 GB SODIMMs (for Intel® Core™ Processors) 8GB and 16 GB ECC SODIMMs (for Intel® XEON® Processors)

Maximum

Upgradeable to 32 GB with optional 16 GB SODIMMs in 2 slots

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

NOTE: Transfer rates up to 2667 MT/s for systems with less than 32 GB. ECC memory only available with Intel® Xeon® processors.

NETWORKING/COMMUNICATIONS

I AN*

Integrated Intel® I219-LM Gigabit Network Connection

Wireless

Support for a broad range of secure, integrated wireless LAN options featuring support for the latest industry standards. Integrated Bluetooth® is also available (factory configurable only) and can be combined with any of the supported wireless LAN options.

802.11 Wireless LAN options**

Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi and Bluetooth® 5.0 Combo Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo, non-vPro™

*The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

**Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service.

Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.



Features

AUDIO/MULTIMEDIA

Audio

Bang & Olufsen HD audio. Integrated stereo speakers and microphone (dual-microphone array when equipped with optional webcam and optional world facing microphone). Functions keys for volume mute, up and down. Combo microphone-in/stereo headphone-out jack.

Webcam*

Optional (720p HD webcam)

Optional (720p HD webcam) IR camera (1080p FHD) for face authentication with Windows Hello

- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- · Improved dynamic range

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Backlit Keyboard* with function key control and numeric keypad

*the Spill resistance is 1mm/min for 10mins not traditional Commercial spill Keyboard

Pointing Devices

Clickpad with multi-touch gesture support

Buttons and Function Keys

Discrete buttons provide easy access to the following features:

- F1 Open App
- F2 Brightness Down
- F3 Brightness Up
- F4 Display Switching
- F5 Keyboard backlight
- F6 Speaker mute
- F7 Volume down
- F8 Volume up Microphone mute
- F9 Plays previous track
- F10 Pause / Play
- F11 Plays next track
- F12 Wireless on/off



^{*}HD content required to view HD images

^{**}Optional or add-on feature

Features

SOFTWARE AND SECURITY

Preinstalled Software with Windows® Operating System

Bing search for IE11; Buy Office (sold separately); HP Client Security Suite Gen4; HP ePrint Driver + JetAdvantage; HP Hotkey Support; HP Noise Cancellation Software; HP Performance Advisor; HP Recovery Manager; HP Remote Graphics Software; HP Support Assistant; HP Velocity; HP WorkWise (requires Bluetooth); Skype for Business Certified; HP LAN-WLAN Protection; HP JumpStart 1,2,3

Security Management

Absolute persistence module; Common Criteria EAL4+ Augmented Certified Discrete TPM 2.0 Embedded Security Chip; DriveLock and Automatic DriveLock; HP FingerPrint Sensor; One-step log-on; Optional USB port disable at factory (user configurable via BIOS); Power-on password (via BIOS); RAID (available as a configurable option); Removable media write/boot control; SATA port disablement (via BIOS); Security lock slot; Serial enable/disable (via BIOS); Setup password (via BIOS); Support for Intel® Anti-Theft Technology; IR camera with Windows Hello 4,5,6,7,8,9

HP Remote Graphics Software

The remote desktop solution for serious workstation users and their most demanding applications.

Download at: http://www.hp.com/go/RGS

HP Performance Advisor

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

Download at: http://www.hp.com/go/performanceadvisor

- 1. HP Remote Graphics Software requires a Windows, Linux®, or Mac®OS X 10.10 and newer operating system and network
- 2. HP Workwise smartphone app is available as a free download on the App Store and Google Play. See requirements at www.hp.com/go/workwise.
- 3. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.
- 4. BIOS Absolute Persistence module is shipped turned off, and will be activated when customers purchase and activate a subscription. Service may be limited. Check with Absolute for availability outside the U.S. The optional
- 5. subscription service of Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement.
- 6. Finger Sensor is optional
- 7. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 8. HP BIOSphere Gen4 requires Intel® or AMD 8th generation processors. HP Sure Start Gen4 is available on HP Z Workstations products equipped with 8th generation Intel® or AMD processors.
- 9. HP Password manager requires Windows.



Features

POWER

Power Supply

120 W Slim Smart AC adapter (external)*
150 W Slim Smart AC adapter (external)

Battery

HP Long Life 3-cell Polymer 52.5Whr (optional) HP Long Life 4-cell Polymer 70Whr

NOTE: Battery is internal and not replaceable by the customer

*120 W Slim Smart AC adapter (external) for UMA Configurations Only

ENVIRONMENTAL

US ENERGY STAR ® IT ECO declaration EPEAT® registered* Low Halogen**

- * EPEAT ® registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.
- **External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

WEIGHTS & DIMENSIONS

Weight

Starting at 4.77 lb (2.165kg)

Dimensions (w x d x h) 10.1 x 14.37 x 1 in 256.5 x 365 x 25.4 mm

PORTS/SLOTS

Ports

Left side:

(2) USB 3.0

Right side:

- (1) HDMI 2.0
- (1) USB Type-C™ (Thunderbolt™ 3, DisplayPort™ 1.3, USB 3.1)
- (1) USB 3.0 Port Charging
- (1) Headphone/Microphone Combo
- (1) RJ-45 / Ethernet



Features

(1) Power connector

Digital Media Slots

(1) SD UHS-II Flash Media slot – Supports next generation SD (Secure Digital), backward compatible to SDHC, SDXC

SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional* HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/cpc.

HP Care Services are sold separately or as an optional feature. Service levels and response times for HP Care Packs
may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and
limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or
indicated to Customer at the time of purchase. Customer may have additional statutory rights according to
applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP
Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.



Technical Specifications – System Unit

SYSTEM UNIT

Stand-Alone Power **Nominal Operating** 19.5 V

Requirements (AC Power) Voltage

Average Operating Power System in idle mode + **UMA 10.58W**

max panel brightness **DIS 9.21W** Adapter Safety test **UMA 116.6W** condition **DIS 144.7W**

Max Operating Power UMA < 120W

DIS < 150W

41°F to 95°F **Temperature** Operating

5°C to 35°C

-4°F to 140°F **Non-operating**

-20°C to 60°C

Relative Humidity Operating 10% to 90%

Non-operating 5% to 95%

Shock **Operating** SVTP test condition: 40G, 2ms, half-sine

> **Non-operating** SVTP test condition: 240G, 2ms, half-sine

Random Vibration SVTP test condition: 1.043 arms Operating

Non-operating SVTP test condition: 3.50 grms

Maximum Altitude Operating -50 ft to 10,000 ft (-15 m to 3,048 m) (unpressurized) **Non-operating** -50 ft to 40,000 ft (15 m to 12,192 m)

Industry Standard Certifications **CSA**

NA **FCC Compliance**

ENERGY STAR® Yes, 6.1 & 7.0 **EPEAT** Yes. Silver **ICES** Yes

Australia / **NZ A-Tick Compliance**

Yes Yes

Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes

MIL STD 810G Temperature, Relative Humidity, Shock, Random Vibration and Altitude



Technical Specifications - Displays

DISPLAYS

15.6" diagonal LEDbacklit FHD IPS AG (1920 x 1080) (220 nits) **Active Area** (W x H) 13.54 x 7.59 in (34.4 x 19.4 cm)

Dimensions (W x H)15.6 in (39.6 cm)Weight360 g (max)Surface TreatmentAnti-glareContrast Ratio600:1 (typical)

Refresh Rate 60 Hz

Brightness* 220nits (typical)

Pixel Resolution Format 1920 x 1080 (FHD)

Configuration RGB Stripe

Backlight LED PPI 141

Viewing Angle 85/85/85 (Left/Right/Down/Up) (typical)

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower."

15.6" diagonal LED FHD IPS Touch (1920 x 1080) (250 nits) **Active Area** (W x H) 13.54 x 7.59 in (34.4 x 19.4 cm)

 Dimensions (W x H)
 15.6 in (39.6 cm)

 Weight
 380 g (max)

Surface Treatment Touch with Gorilla® Glass 4

Contrast Ratio 400:1 (typical)

Refresh Rate 60 Hz

Brightness* 250 nits (typical)

Pixel Resolution Format 1920 X 1800 (FHD)

Configuration RGB Stripe

Backlight LED PPI 141

Viewing Angle 45/45/35/25 (Left/Right/Down/Up) (typical)

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower."

15.6" diagonal UHD IPS LED AG (3840x2160) (340 nits) **Dimensions** (W x H) 13.62 x 7.59 in (3.6 x 19.4 cm)

Diagonal Size15.6 in (39.6 cm)Weight345 g (max)Surface TreatmentAnti-glareContrast Ratio1000:1 (min)Refresh Rate60 Hz

00112

Brightness* 340 nits (typical)

Pixel Resolution Pitch 0.090 x 0.090 mm

Format 3840x2160 Configuration RGB Stripe

Interface eDP



Technical Specifications - Displays

Backlight LED PPI 282

Viewing Angle 85/85/85 (Left/Right/Down/Up) (typical)

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower."



Technical Specifications - Storage and Drives

STORAGE AND DRIVES

Internal Storage

2 TB 5400 rpm SATA Hard Drive Weight

Disk Drive

Drive Weight 0.21 lbs (95 g)

Capacity 2 TB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s
Seek Time Single Track 2 ms

(typical reads, including Average

settling)

 Average
 12 ms-13 ms

 Maximum
 18 ms-22 ms

Cache128 MBRotational Speed5400 rpmLogical Blocks3,907,029,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA Disk Hard Drive **Drive Weight** 0.20 lbs (92 g) ~ 0.25 lbs (115 g)

Capacity 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track1.5 ms ~ 2 ms(typical reads, including settling)Average11 ms ~ 13 msMaximum18 ms ~ 22 ms

CacheUp To 32 MBRotational Speed7200 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA



Technical Specifications - Storage and Drives

1 TB 7200 rpm SATA Hard Drive Weight

Disk Drive

Orive Weight 0.21 lbs (95 g)

Capacity 1 TB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track1.5 ms(typical reads, including
settling)Average13 msMaximum32 ms

Cache128 MBRotational Speed7200 rpmLogical Blocks1,953,525,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB Hybrid Drive, 8 GB cache **Drive Weight** 0.198 lbs (90 g) ~ 0.20 lbs (92 g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s

Seek Time Single Track 1.5 ms ~ 2 ms (typical reads, including settling)

Average 12 ms ~13 ms 22 ms ~ 32 ms

CacheUp to 128MBRotational Speed5400 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

1 TB Hybrid Drive, 8 GB cache **Drive Weight** 90g **Capacity** 1 TB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek Time Single Track 600 MB/s (typical reads, including settling) Average 1.5 ms

CacheUp to 128MBRotational Speed5400 rpmLogical Blocks1,953,525,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Technical Specifications - Storage and Drives

Features ATA Security, S.M.A.R.T., NCQ, Ultra DMA

2 TB Hybrid Drive, 8 GB cache **Drive Weight** 90g **Capacity** 2 TB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer RateSynchronous (maximum)600 MB/sSeek TimeSingle Track1.5 ms(typical reads, including settling)Average13 msMaximum32 ms

CacheUp to 128MBRotational Speed5400 rpmLogical Blocks3,907,029,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA SED Hard Disk Drive Drive Weight0.21 lbs (95g)Capacity500 GBHeight0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track2 ms(typical reads, including
settling)Average12 msMaximum18-22 ms

Cache32 MBRotational Speed7200 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features ATA Security, TCG Opal v1.00, S.M.A.R.T., NCQ, Ultra DMA

256 GB SATA TLC Solid State Drive (2.5")

 Drive Weight
 0.17 lb (78 g)

 Capacity
 256 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

NAND TLC
Form Factor (I/O) 2.5 inch

Interface

Performance Maximum Sequential Read Maximum Sequential Write

530 MB/s ~ 560 MB/s 500 MB/s ~ 525 MB/s

Logical Blocks 500,118,192

ATA-8, SATA 3.0

Technical Specifications - Storage and Drives

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP

1 TB SATA TLC Solid State Drive Weight 0.17 lb (78 g)

Drive (2.5") Capacity 1 TB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

NAND TLC Form Factor (I/O) 2.5 inch

Performance Maximum Sequential Read Maximum Sequential Write

530 MB/s ~ 560 MB/s 500 MB/s ~ 530 MB/s

Logical Blocks 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP

256 GB M2 SED TLC Solid Drive Weight State Drive Capacity

 Drive Weight
 0.02 lb (<10 g)</td>

 Capacity
 256 GB

Height 0.14 in (3.58 mm)- 0.09 in (2.23 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Generation ??

NAND TLC

Form Factor (I/O) M.2 2280

Performance Maximum Sequential Read Maximum Sequential Write

Up to 530 MB/s UP to 515 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TCG Opal 2.0, DIPM; TRIM; DEVSLP

256 GB M.2 NVMe TLC Solid State Drive

 Drive Weight
 0.02 lb (<10 g)</td>

 Capacity
 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

Generation Samsung PM961/ Toshiba XG5

NAND Type TLC Form-Factor (I/O) M.2 2280

Interface PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

2580 MB/s ~ 2600 MB/s 1000 MB/s ~ 1100 MB/s

Logical Blocks 500,118,192

Technical Specifications - Storage and Drives

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option),TRIM; L1.2

256 GB M.2 NVMe TLC SED Drive Weight 0.02 lb (<10 g)
Solid State Drive Capacity 256 GB

Capacity 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

Generation Samsung PM961 SED Opal2/ Toshiba XG5 SED Opal2

NAND Type TLC Form-Factor (I/O) M.2 2280

Interface PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

2580 MB/s ~ 2600 MB/s Up to 1000 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

512 GB M.2 NVMe TLC Drive Weight 0.02 lb (<10 g)
Solid State Drive Capacity 512 GB

Capacity 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

Generation Samsung PM981 / Toshiba XG5

NAND Type TLC Form-Factor (I/O) M.2 2280

Interface PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

2800 MB/s ~ 2900 MB/s 1000 MB/s ~ 1800 MB/s

Logical Blocks 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security, TRIM; L1.2

512 GB M.2 NVMe TLC SED Drive Weight 0.02 lb (<10 g)
Solid State Drive Capacity 512 GB

Capacity 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

Generation Samsung PM981 SED Opal2/ Toshiba XG5 SED Opal2

NAND Type TLC Form-Factor (I/O) M.2 2280

Interface PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

Technical Specifications - Storage and Drives

2800 MB/s ~ 2900 MB/s

1000 MB/s ~ 1800 MB/s

Logical Blocks

1,000,215,215

Operating Temperature

32° to 158°F (0° to 70°C) [ambient temp]

Features

ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

1 TB, M.2 NVMe TLC Solid Drive Weight **State Drive**

0.02 lb (<10 q)

Capacity

1 TB

Height Width

0.09 in (2.3 mm) 0.87 in (22 mm)

Generation

Samsung PM981 / Toshiba XG5

NAND Type

TLC

Form-Factor (I/O)

M.2 2280

2,000,409,264

Interface

PCIe NVMe Gen3X4

Performance

Maximum Sequential Read

Maximum Sequential Write Up to 2000MB/s

Logical Blocks

Operating Temperature

32° to 158°F (0° to 70°C) [ambient temp]

Features

ATA Security, TRIM; L1.2

2900 MB/s ~ 3000 MB/s

2 TB, M.2 NVMe TLC Solid Drive Weight **State Drive**

0.02 lb (<10 g)

Capacity Height

2 TB

Width Generation 0.09 in (2.3 mm) 0.87 in (22 mm) Toshiba XG5P

NAND Type Form-Factor (I/O) TLC M.2 2280

Interface

PCIe NVMe Gen3X4

Performance

Logical Blocks

Maximum Sequential Read

Up to 2100 MB/s

Maximum Sequential Write

Up to 2900MB/s

3,907,029,168

Operating Temperature

32° to 158°F (0° to 70°C) [ambient temp]

Features

ATA Security, TRIM; L1.2



^{*}For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) disk is reserved for system recovery software.

Technical Specifications - Security

SECURITY

HP Fingerprint Reader Mobile Voltage Operation 3.0V-3.6V Single Supply

Operating Temperature 14° - 167°F (-10° - 75°C)

Current consumption 36mA

image

Low latency wait for 950 uA

finger

Capture rate 3000 lines/sec

ESD Resistance IEC 6100-4-2 4B (+/-15KV)

Detection Matrix 200*1 (plus another secondary line); 508 dpi, sensor area 12*3 mm



Technical Specifications – Networking

NETWORKING/COMMUNICATION

Power

Intel® I219-LM Gigabit Network Connection Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-

14)

100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses

13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses

21-30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023.

Clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and

100 Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE(Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection ACPI compliant - multiple power modes

ManagementEnergy Detect Low Power Mode(Green Ethernet)PerformanceTCP/IP/UDP Checksum Offload (configurable)

Features Protocol Offload(ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling MACSec Offload (802.3ae)

Intel® vPro iSCSI Boot

RSS is kernel based support (e.g. in Win Server 2013)

Ultra Low Power at cable disconnect (<1mW) enables platform

support for connected standby.

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet

only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB

(802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ.

NOTE: Intel® I219-LM Gigabit interface is not PCIe compliant. It

operates at half of PCIe specification V1.1 (2.5GT/S) speed.

NIC Device Driver Name Intel® Ethernet Network Connection I219-LM



Technical Specifications – Networking

Intel® Dual Band Wireless-N 9560AC 802.11 a/b/g/n (2x2) WiFi + Bluetooth 5.0 Combo Adaptor* Wireless LAN Standards
IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
Interoperability
Wi-Fi certified

Frequency Band 802.11b/g/n 2.402 - 2.482 GHz

Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise

disable those channels

802.11a/n 4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

Note: Indonesia only supports 5.725 - 5.825 GHz

(CH149 - CH161)

Data Rates 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15 (20MHz and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and

80MHz)

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM

Security¹

 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and

CCX Lite

WAPI

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between band Access Points

Output Power² 802.11b: +16dBm minimum 802.11g: +14dBm minimum

802.11g : +14dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +12dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +12dBm minimum

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps : -86dBm maximum



Technical Specifications – Networking

802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -88dBm maximum 802.11a, 54Mbps: -74dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 2SS, MCS-9: -61dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna Type High efficiency antenna with spatial diversity, mounted in the

display enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth

communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230: 2.8g

0r

Type 1630 : 2g 3.3v +/- 9%

Operating Voltage 3.3v +/- 9%
Temperature Operating

Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).

* Wireless access point and internet service required. Availability of public wireless access points limited.

HP Integrated Module with Bluetooth 4.2 Wireless Technology

Bluetooth Specification4.2 CompliantFrequency Band2402 to 2480 MHzNumber of Available
ChannelsLegacy : 0~79 (1 MHz/CH)
BLE : 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE : 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.



Technical Specifications – Networking

Receiver Sensitivity

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface

USB 2.0 compliant

Bluetooth Software

Supported

Microsoft Windows® Bluetooth Software

Link TopologyPoint to Point, Multipoint Pico Nets up to 7 slavesSecurityFull support of Bluetooth Security ProvisionsPower ManagementMicrosoft Windows® ACPI, and USB Bus Support

Self-configurable to optimize power conservation in all operating modes,

including Standby, Hold, Park, and Sniff

Certifications All necessary regulatory approvals for supported countries, including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

Serial Port Profile (SPP)
Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)

Generic Object Exchange Profile (GOEP)

Object Push Profile (OPP)

Hard Copy Cable Replacement (HCRP)
Personal Area Networking Profile (PAN)
Human Interface Device Profile (HID)

Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP) Audio Video Remote Control Profile (AVRCP)

AUDIO/MULTIMEDIA – BANG & OLUFSEN

Hardware Implementation Realtek ALC3258

Function Key Volume Controls

Volume up, volume down, and Mute

Full Duplex Yes

Microphone In Mono, (combo jack)

Headphone/Line Out Stereo

Integrated Microphone Yes, Digital Microphone Array

Audio Output Quality Frequency Response 20 Hz ~ 20kHz

Signal to Noise Ratio 100dBFSA

Total Harmonic Oistortion-45 dBFS / Headphone Out @32ohms



Technical Specifications – Networking

Noise Floor < -80 dB Play Sampling Rate(s) 48kHz

Record Sampling Rate(s) Up to 192kHz
DAC 16 or 24-Bit
ADC 16, 20 or 24-Bit

Internal Stereo Speaker Power Rating 2 Watts

Impedance 4 ohms



Technical Specifications - Power

POWER

HP 150W Slim Smart AC Adapter **Dimensions** 6.02 x 2.60 x .87 in (153 x 66 x 22 mm)

Weight 325 g

Input 100 to 240 VAC

Input Efficiency 88% min at 115 VAC

89% min at 230VAC

Input frequency range 47 to 63 Hz

Input AC current 2.7 A at 90 VAC

Output Output power 150W

DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <15A, Over voltage protection- 29V max

automatic shutdown

Connector3 pin/grounded, mates with interchangeable cordsEnvironmental DesignOperating32° to 95° F (0° to 35° C)

temperature

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 5% to 95% Storage Humidity 5% to 95%

EMI and Safety Certifications CE Mark- full compliance with LVD and EMC directives; Worldwide safety standards- IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 100,000 hours at 25°C ambient condition.

HP 120W Slim Smart AC Adapter **Dimensions** 148 x 75.5 x 25.4mm

Weight 485 q

Input 100 to 240 VAC

Input Efficiency 88% min at 115 VAC

89% min at 230VAC

Input frequency range 47 to 63 Hz

Input AC current 2.2 A at 90 VAC

Output Output power 120W

DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <16A, Over voltage protection- 29V max

automatic shutdown

Connector 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 32° to 95° F (0° to 35° C)

temperature

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 5% to 95%

Technical Specifications - Power

Storage Humidity 5% to 95%

EMI and Safety Certifications CE Mark- full compliance with LVD and EMC directives; Worldwide safety standards- IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 100,000 hours at 25°C ambient condition.

HP Long Life 4-cell Polymer Battery (70 WHr) **Dimensions** (H x W x L) 0.31 x 3.66 x 9.56 in (0.79 x 9.29 x 24.3 cm)

Weight (max) 0.61lb (275g)
Cells/Type 4-cell; Polymer

Energy Voltage 15.4V Amp-hour capacity 4.55Ah

Watt-hour capacity 70Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C) Non-operating -4° to 140° F (-20° to 60° C)

3 hours

Battery Re-Charge Time System in OFF or Standby

Mode

System ON 3 to 5 hours

Charge Rate 0.7C; HP Fast Charge 90% in 90 minutes

Fuel Gauge LED No Warranty* 3 year Compatible with optional N/A

Travel Battery

HP Long Life 3-cell Polymer Battery (52.5 WHr)

Dimensions (H \times W \times L)

0.31 x 3.66 x 9.56 in (0.79 x 9.29 x 24.3 cm)

Weight (max) 0.49 lb (220g)
Cells/Type 3-cell; Polymer

Energy Voltage 11.55V Amp-hour capacity 4.55Ah

Watt-hour capacity 52.5Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C) Non-operating -4° to 140° F (-20° to 60° C)

Battery Re-Charge Time System in OFF or Standby 3 hours

Mode

System ON 3 to 5 hours

Charge Rate 0.7C; HP Fast Charge 90% in 90 minutes

Fuel Gauge LED No
Warranty* 3 year
Compatible with optional N/A

Travel Battery

^{* 3-}year platform warranty is required for a 3-year Long Life Battery warranty.

^{* 3-}year platform warranty is required for a 3-year Long Life Battery warranty.

Technical Specifications - Environmental Data

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method

ENERGY STAR® test method)	115VAC, 60HZ	230VAC, 50HZ	100VAC, 50Hz
Normal Operation (Sort idle)	TBD	TBD	TBD
Normal Operation (Long idle)	TBD	TBD	TBD
Sleep	TBD	TBD	TBD
Off	TBD	TBD	TBD

Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	TBD	TBD	TBD
Normal Operation (Long idle)	TBD	TBD	TBD
Sleep	TBD	TBD	TBD
Off	TBD	TBD	TBD

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured — Idle	TBD	TBD
Fixed Disk – Random writes	TBD	TBD
Optical Drive – Sequential reads	TBD	TBD

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 4 USB ports
- 2 Thunderbolt[™] 3 ports
- 2 2.5" Storage Bay Drives
- 2 M.2 SATA SED Solid State Drives



Technical Specifications - Environmental Data

- 1 Smart Card Reader
- 1 SD Card reader
- 4 SODIMM memory slots
- 1 HDMI 1.4 port

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Battery size: 4-cell high capacity Lithium-Ion battery (optional 3 cell available)

Battery type:

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0.0% post-consumer recycled plastic (by wt.)

This product is 95.2% recycle-able when properly disposed of at end of life.

Packaging Materials

External:	PAPER/Corrugated	445 g
Internal:	PLASTIC/Polyethylene low density - LDPE	19 g
	PLASTIC/Polyethylene Expanded - EPE	90 g
	PLASTIC/Polypropylene - PP	7 g

The plastic packaging material contains at least 81.5% recycled content.

The corrugated paper packaging materials contains at least 80.0% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.



Technical Specifications - Environmental Data

- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Memory	HP 8GB DDR4-2666 SODIMM	TBD
	HP 16GB DDR4-2666 SODIMM	TBD
	HP 32GB DDR4-2666 SODIMM	TBD
	HP 8GB DDR4-2666 ECC SODIMM	TBD
	HP 16GB DDR4-2666 ECC SODIMM	TBD
	HP 32GB DDR4-2666 ECC SODIMM	TBD
Cases	HP Professional slim Top Load Case	H4J91AA
Docking	HP ZBook Dock with Thunderbolt™ 3 (150W)	P5Q58AA
	HP ZBook Dock with Thunderbolt™ 3 (200W)	P5Q61AA
	HP Executive Travel Hub	TOK29AA
	HP Travel Hub	TOK30AA
	HP Elite USB-C Desk Dock	Z9R42AA
	HP Elite USB-C Desk Dock 2	2DW60AA
	HP Thunderbolt™ Dock 230W G2	2UK38AA
	HP USB-C Universal Dock	1MK33AA
	HP USB-C Mini Dock	1PM64AA
	HP USB-C to USB-A Hub	Z6A00AA
	Elite USB-C Dock	X7W54AA
	HP ZBook Thunderbolt™ 3 1m cable	Z4P20AA
	HP Thunderbolt™ 1m combo cable	3AQ25AA
Input/Output -	HP Slim USB Keyboard and Mouse	T6T83AA
Mice	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wireless (Link-5) Keyboard	T6U20AA
	HP 3-Button Laser Mouse	H4B81AA#xxx
	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP X4000 Bluetooth Mouse	H3T50AA#xxx
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Bluetooth mouse	F3J92AA#xxx
	HP USB Premium Mouse	1JR32AA
	HP Wireless Premium Mouse	1JR31AA
Displays	HP DreamColor Z27x Studio Display	D7R00A8
Power Adapters	HP 150W Slim A/C Adapter	W2F74AA
Adapters	HDMI to DVI adapter	F5A28AA
	HP USB Smart Card Reader	F6V67AA
	HP dual output wireless adapter	C5U89AA
	USB-C to RJ45	V7W66AA



Options and Accessories (sold separately and availability may vary by country)

	USB 3.0 to RJ45	N7P47AA
	USB-C to HDMI 1.4	N9K77AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to DisplayPort™ Adapter	N9K78AA
	HDMI to VGA Adapter	H4F02AA
	HDMI to DVI adapter	F5A28AA
	USB-C to DP	TBD
	USB-C to TB1/TB2	TBD
	7.4 to 4.5mm Adapter	K0Q39AA
Collaboration	HP USB Collaboration Keyboard	Z9N38AA#xxx
	HP Wireless Collaboration Keyboard	Z9N39AA#xxx
	HP USB Speaker Phone	X7N17AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	UCC Wireless Earpiece	W3K08AA
	UCC Wireless Duo Headset	W3K09AA
	HP Conferencing Keyboard	K8P74AA#xxx
	HP Speaker Phone	K7V16AA
	HP Wired Headset	K7V17AA
Storage - External	HP 1TB 7200RPM 9.5mm SATA HDD	L3M56AA
Storage	HP 500GB 7200rpm HDD	F3B97AA
	HP 256GB TLC SDD	MOF34AA
	HP 256GB M2 PCIe SSD (2280)	V3K66AA
	HP 512GB M2 PCIe SSD (2280)	V3K67AA
	HP 256GB TLC PCI-e 3x4 NVMe M.2 SSD	1FU87AA
	HP 512GB TLC PCI-e 3x4 NVMe M.2 SSD	1FU88AA
	HP USB External DVDRW Drive	F2B56AA
Security	HP 15.6" Notebook PC Privacy Filter	J7H71AA
	HP Nano Keyed Cable Lock	1AJ39AA



for Notebooks

HP Nano Dual Head Keyed Cable Lock

HP 3 year Next business day onsite Hardware Support w/Accidental Damage Protection-G2

1AJ41AA

UF631E

Summary of Changes

Date of change:	Version History:	Description of change:
	From v1 to v2	



Copyright © 2018 HP Development Company, L.P.

The information contained herein is subject to change without notice. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Intel, Core, vPro, Xeon, Celeron and Thunderbolt[™] are registered trademarks or trademarks of Intel Corporation in the U.S. and/or other countries. Bluetooth is a registered trademark of its proprietor, used by HP Inc. under license. Adobe is a trademark of Adobe Systems Incorporated. Qualcomm and Snapdragon are trademarks of Qualcomm, Inc. ENERGY STAR is a registered trademark mark of the U.S. Environmental Protection Agency. Microsoft and Windows are registered trademarks of Microsoft Corporation in the United States and/or other countries. AMD, Enduro and FirePro are trademarks of Advanced Micro Devices, Inc. NVIDIA, the NVIDIA logo, Optimus and Quadro are trademarks and/or registered trademarks of NVIDIA Corporation in the U.S. and other countries. SD, SDHC, and SDXC are trademarks or registered trademarks of SD-3C in the United States, other countries or both. USB Type-C and USB-C are trademarks of USB Implementers Forum. DisplayPort™ and the DisplayPort™ logo are trademarks owned by the Video Electronics Standards Association (VESA®) in the United States and other countries.

